

ALPHA® TELECORE® HF-850

HALOGEN-FREE, HALIDE-FREE, NO-CLEAN, CORED SOLDER WIRE

DESCRIPTION

ALPHA Telecore HF-850 is the fastest wetting and lowest spattering, Halogen Free and Halide Free cored wire offering from **ALPHA**. It performs admirably when benchmarked against Halogen and Halide containing competitive products available in the market and is a viable option to meet environmental requirements.

ALPHA Telecore HF-850's rapid wetting enables its use in drag soldering and minimizes cycle time in robotic and hand soldering applications. Its clear residue allows easy inspection of solder joints and the very low spatter rate ensures board cosmetics and user comfort are maintained. All this translates to a safe and environmentally compliant product that is operator friendly while maintaining high levels of productivity.

FEATURES & BENEFITS

- *Very fast wetting* → *Low Cycle times for component touch-up and manual assembly*
- *Very low flux spatter* → *Safe to use, Operator Friendly, Less Residues on Boards*
- *Good spread characteristics* → *Excellent First Pass Solder Joints. JIS Spread ≥ 80%.*
- *Very low levels of fumes* → *Cleaner Working Environment, Less Extraction Maintenance*
- *Clear non-tacky residue* → *No-Clean Residues, Useful for all Applications*
- *Provides good joint appearance* → *Makes Inspection easy*
- *Halogen and Halide Free* → *Environmental compliance and High Electrical Reliability*

ALPHA Telecore HF-850 is suitable for use in any electronic or industrial no-clean soldering application that specifies compliance to the IPC J-STD-004 ROL0 standard. It is ideal for electronic assemblies used in Automotive, Consumer Electronics, Computer and peripherals, Mobile devices and all types of household appliance applications.

PRODUCT INFORMATION

Standard	Alloy Designation	Melting or Solidus / Liquidus Temp °C	Flux Amount
	InnoLot** Sn90.85/Ag3.8/Cu0.7/Sb1.5/Ni0.15/Bi3.0 (High reliability and high operating temperature)	206 - 218	2.2%
J-STD-006C	SAC305	217 - 221	1.1%, 2.2% & 3.3%
Proprietary	SACX Plus® 0807	217 - 228	2.2% & 3.3%
Proprietary	SACX Plus 0307	217 - 228	2.2% & 3.3%

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Proprietary	SnCX Plus 07	227 – 229	2.2% & 3.3%
J-STD-006C	Sn99.3/Cu0.7	227	2.2% & 3.3%
J-STD-006C	Sn63/Pb37	183	1.1%, 2.2% & 3.3%
ISO 9453	Sn99Cu1	227	2.2% & 3.3%

* TELECORE HF-850 may also available in other alloys and flux amounts on request.

** All electronic components used with InnoLot solder alloy must be lead-free to eliminate the formation of tin/lead/bismuth intermetallic which has a melting point under 100°C

APPLICATION

A soldered joint is formed by heating the parts to be soldered to a temperature in excess of the melting point of the alloy to be used – in hand soldering this is how a soldering iron is used. By feeding the cored wire onto the parts, the flux is able to flow and remove oxidized metal, while the solder creates a thin inter-metallic bond which becomes the solder joint. **ALPHA Telecore HF-850** is also ideal for robotic soldering applications.

Note the following tips:

- Use a soldering iron tip size and form to suit the operation: small tips for soldering large components may prevent the formation of a joint or slow the process down.
- Select a solder wire diameter to suit both the soldering iron tip and the parts/components to be soldered.
- Soldering iron systems should provide sufficient heat to satisfy the requirements of the points above.
- A typical solder tip temperature would be between 120°C and 160°C above the liquidus temperature of the alloy. The ideal temperature to use is dependent on how thermally demanding the assembly is.
- Cored solder wires can be provided in different grades of alloy so always ensures that you have selected the right grade for the application.
- Do not overheat as this causes an increase in the depth of the inter-metallic layer, which in turn weakens the joint.

If you choose to use a liquid rework flux, **ALPHA NR205** No-Clean Low Residue Flux is recommended to maintain high electrical reliability and halogen-free residues. **ALPHA NR205** is available in Alpha's Write Flux Pens for precision flux application.

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HALOGEN STATUS

ALPHA TELECORE HF-850 is a Halogen Free product and passes the standards listed in the Table below:

Halogen Standards			
Standard	Requirement	Test Method	Status
IEC 612249-2-21	Post Soldering Residues contain < 900 ppm each or total of < 1500 ppm Br or Cl from flame retardant source	TM EN 14582	Pass
JEDEC <i>A Guideline for Defining "Low Halogen" Electronics</i>	Post soldering residues contain < 1000 ppm Br or Cl from flame retardant source		Pass

TECHNICAL DATA

Physical Properties	Typical Values
Rosin Softening Point:	70°C – 80°C
Acid Value:	180 - 200 mg KOH/g flux (IPC-TM-650-2.3.13)
Halide Content:	<500 ppm (IPC-TM-650-2.3.28.1)
Classification:	JIS - 1a3N Grade AA ROL0 per IPC J-STD-004A/B

Chemical Reliability Test	Requirements	Results
Copper Mirror Test (JIS)	No complete removal of copper	PASS
Copper Mirror Test (IPC-TM-650- 2.3.32)	No complete removal of copper	PASS
Copper Corrosion Test (JIS)	No evidence of corrosion	PASS
Copper Corrosion Test IPC-TM-650-2.6.15	No evidence of corrosion	PASS

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Electrical Reliability Test	Product Combination	Requirements	Results
Automotive Damp-Heat Cyclic Test (IEC 60068-2-78)	Telecore HF-850	1.0 × 10 ⁸ Ω minimum *	PASS
	Telecore HF-850 + CVP390 Solder Paste		PASS
JIS SIR Test (JIS-Z-3197)	Telecore HF-850	1.0 × 10 ¹¹ Ω minimum	PASS
JIS WER Test (JIS Z 3283:2006)	Telecore HF-850	WER Grade AA >1000 ohm-m	PASS
IPC SIR Testing (J-STD-004B)	Telecore HF-850	1.0 × 10 ⁸ Ω minimum	PASS
	Telecore HF-850 + CVP390 Solder Paste + EF6100 Liquid Flux		PASS
	Telecore HF-850 + CVP390 Solder Paste + NR205 Liquid Flux		PASS
IPC SIR Testing (J-STD-004A)	Telecore HF-850	1.0 × 10 ⁸ Ω minimum	PASS
Bellcore SIR Test (GR-78-CORE)	Telecore HF-850	1.0 × 10 ¹¹ Ω minimum	PASS
Bellcore EM Test (GR-78-CORE)	Telecore HF-850	SIR(initial)/SIR (Final) < 10	PASS

* IEC 60068-2-78 does not specify a minimum resistance value. Alpha has adopted the stated value.

SAFETY

Observe standard precautions for handling and use. Use in well ventilated areas. DO NOT SMOKE during use.

ALPHA Telecore HF-850 wire is not considered toxic. However, its use in typical soldering applications will generate a small amount of decomposition and fumes. These fumes should be adequately exhausted / vented for operator safety and comfort.

Consult the SDS for all safety information. The most recent version of the SDS is available from alphaassembly.com.

STORAGE

ALPHA Cored Solder Wires should be stored in dry conditions and within a temperature range of 0°C to 40°C. Alpha guarantees the product shelf life for three years from the date of manufacture when stored in the recommended conditions.

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CONTACT INFORMATION

To confirm this is the most recent issue, please contact Alpha Assembly Solutions

AlphaAssembly.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency directory assistance Chemtrec 1 - 800 - 424 - 9300.

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